



# DATA SHEET

## SPY0029A

### Linear Regulator

***Preliminary***

OCT. 15, 2002

Version 0.2

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## LINEAR REGULATOR

### 1. GENERAL DESCRIPTION

The SPY0029A is a voltage regulator IC with ultra-low quiescent current and low voltage detection by CMOS process. It operates to +7.0V input range and delivers up to 50mA.

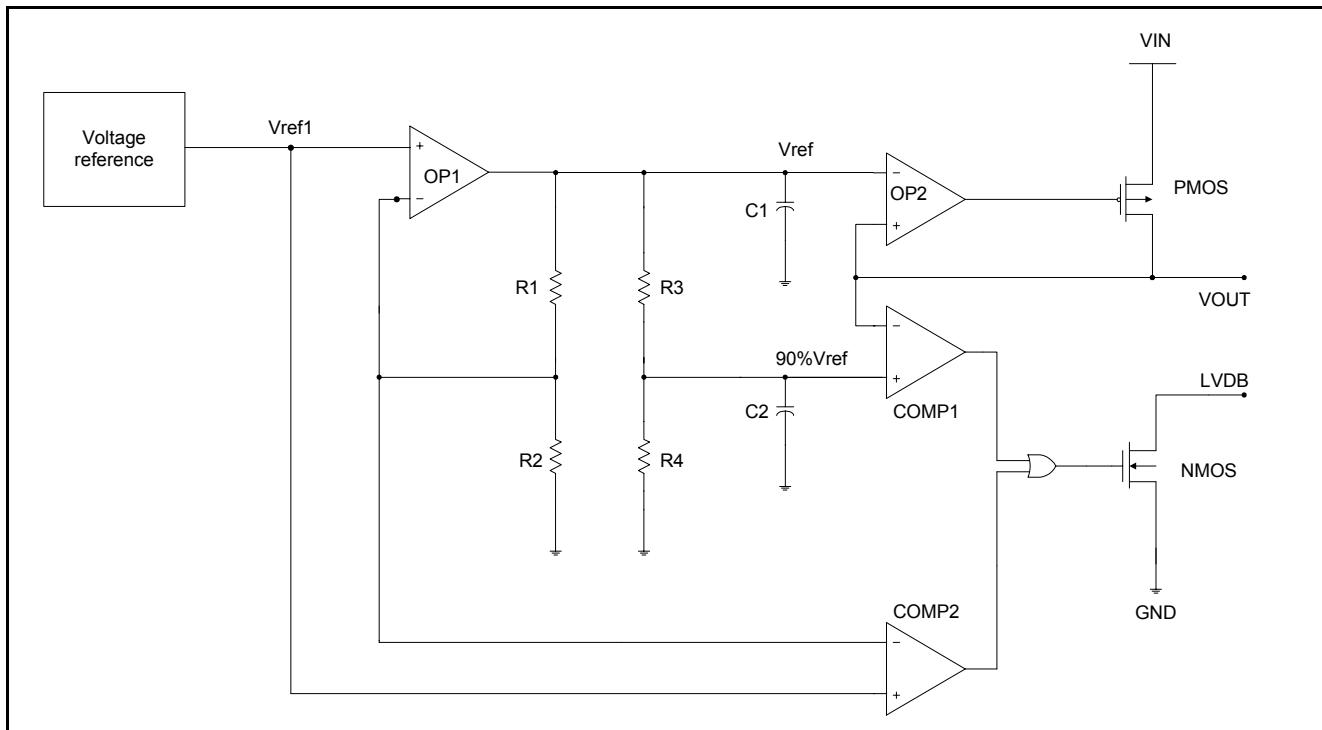
### 2. APPLICATION

- Battery-powered equipment
- Hand-held communication equipment
- Audio/Video system
- Toys

### 3. FEATURES

- Low Quiescent Current (Typ.  $3\mu A$  @  $V_{OUT} = 3.3V$ ,  $V_{IN} = 5.0V$ )
- High Current Driving Capability (Typ. 50mA @  $V_{OUT} = 3.3V$ ,  $V_{IN} = 5.0V$ )
- Small Dropout Voltage (Typ. 40mV @  $V_{OUT} = 3.3V$ ,  $I_{OUT} = 1.0mA$ )
- Low Temperature-Drift Coefficient of Output Voltage (Typ.  $\pm 50ppm/\text{^\circ C}$ )
- Excellent Line Regulation (Typ. 0.15%/V)
- Bonding Options Output Voltage (2.55V, 2.7V, 3.0V, 3.3V)
- High Accuracy Output Voltage ( $\pm 5\%$ )
- Low Voltage Detection.  
(A. Overload detection, B. Low battery detection)
- 3 pin and 4 pin Types of Package or Dice Form

### 4. BLOCK DIAGRAM



## 5. SIGNAL DESCRIPTIONS

### 5.1. 4 PIN (SOT-92)

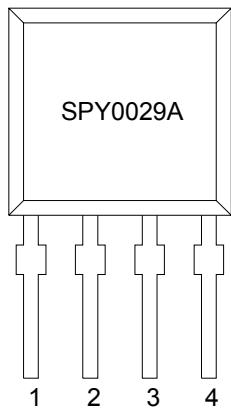
Mnemonic	PIN No.	Type	Description
GND	1	G	Chip Ground
VIN	2	I	Input Voltage.
VOUT	3	O	Output Regulated Voltage.
LVDB	4	O	Low voltage detection, Low activity

### 5.2. 3 PIN (SOT-89)

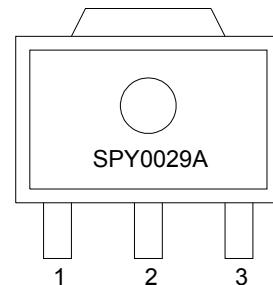
Mnemonic	PIN No.	Type	Description
GND	1	G	Chip Ground
VIN	2	I	Input Voltage.
VOUT	3	O	Output Regulated Voltage.

### 5.3. PIN Configuration

SOT-92



SOT-89





## 6. ELECTRICAL SPECIFICATIONS

### 6.1. Absolute Maximum Ratings

Characteristic	Symbol	Rating	Unit
Input Voltage	V <sub>IN</sub>	+7.0V	V
Output Voltage	V <sub>OUT</sub>	-0.3 ~ (V <sub>IN</sub> + 0.3)	V
Operating Temperature	T <sub>OPT</sub>	0 - 70	°C
Storage Temperature	T <sub>STG</sub>	-40 - 125	°C

Note: Stresses beyond those given in the Absolute Maximum Rating table may cause operational errors or damage to the device. For normal operational conditions see Electrical Characteristic

### 6.2. DC Characteristic

(V<sub>OUT</sub> (target) = 3.3V / 3.0V / 2.7V / 2.55V, Typical values are at T<sub>OPT</sub> = 25°C)

Item	Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Output Voltage Accuracy	V <sub>IN</sub> = 5.0V, 10µA ≤ I <sub>OUT</sub> ≤ 10mA , V <sub>OUT</sub> = 3.3V	V <sub>OUT</sub> - V <sub>OUT</sub> (target) V <sub>OUT</sub> (target)	-5.0	-	5.0	%
Output Current	V <sub>IN</sub> = 5.0V , V <sub>OUT</sub> = 3.3V	I <sub>OUT</sub>	35	50	-	mA
Load Regulation	V <sub>IN</sub> = 5.0V, 1mA ≤ I <sub>OUT</sub> ≤ 50mA , V <sub>OUT</sub> =3.3V	△V <sub>OUT</sub>	-	40	60	mV
Dropout Voltage	I <sub>OUT</sub> = 1mA, Vin = V <sub>OUT</sub> (normal), V <sub>DIF</sub> = V <sub>IN</sub> - V <sub>OUT</sub> , V <sub>OUT</sub> = 3.3V	V <sub>DIF</sub>	-	40	60	mV
Quiescent Current	V <sub>IN</sub> = 5.0V , V <sub>OUT</sub> = 3.3V	I <sub>SS</sub>	-	3.0	6.0	µA
Line Regulation	I <sub>OUT</sub> = 1mA, V <sub>OUT</sub> + 0.5V ≤ V <sub>IN</sub> ≤ 7.0V , V <sub>OUT</sub> = 3.3V	△V <sub>OUT</sub> ΔVin × V <sub>OUT</sub>	-	0.15	-	%/V
Input Voltage	V <sub>OUT</sub> = 3.3V	V <sub>IN</sub>	-	-	7.0	V
Temperature Coefficient	I <sub>OUT</sub> = 10mA, 0°C ≤ T <sub>OPT</sub> ≤ 70°C , V <sub>OUT</sub> = 3.3V	△V <sub>OUT</sub> ΔT	-	±50	-	ppm/°C
Low Voltage Detection Threshold	V <sub>OUT</sub> (A) 1- V <sub>OUT</sub> (Normal)	V <sub>DET</sub>	5.0	10	15	%
	(B) △V = V <sub>OUT</sub> (Normal) - V <sub>IN</sub> , V <sub>OUT</sub> = 3.3V	△V	-	±60	-	mV
LVDB Output Voltage Low (Open Nmos Drain)	I <sub>SINK</sub> = 1mA , V <sub>OUT</sub> = 3.3V	V <sub>O_L</sub>	-	-	0.4	V

Note: V<sub>OUT</sub> (normal) @ V<sub>IN</sub> = 5.0V, I<sub>OUT</sub> = 1mA , Vout = 3.3V , T<sub>OPT</sub> = 25 °C

### 6.3. Bonding Option (several output voltage)

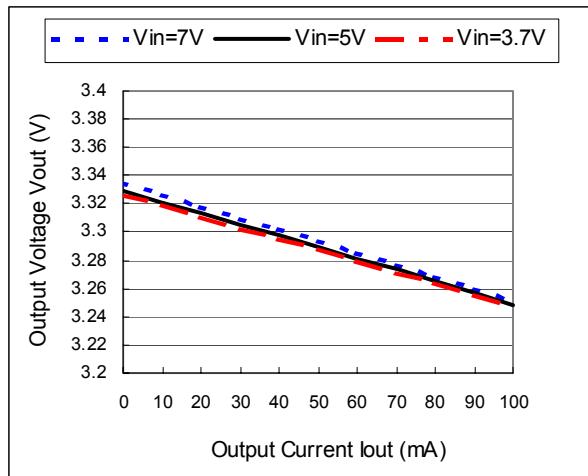
Option	Output voltage	Power source bonding PAD no.
1	3.3V	2 (note1)
2	3.0V	2 & 6 (note 2)
3	2.7V	2 & 5 & 6 (note 3)
4	2.55V	2 & 5 (note 4)

Note 1	Note 2	Note 3	Note 4

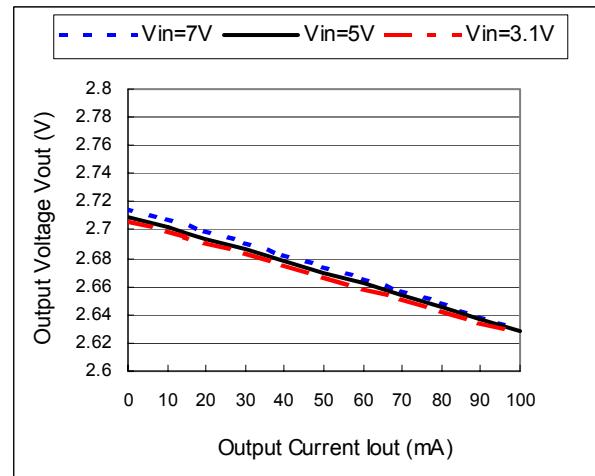


#### 6.4. Typical Operating Characteristics

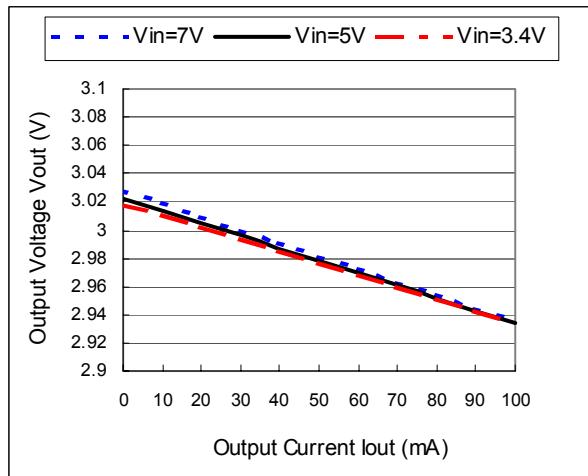
##### 6.4.1. Output voltage vs. output current ( $V_{out} = 3.3V$ )



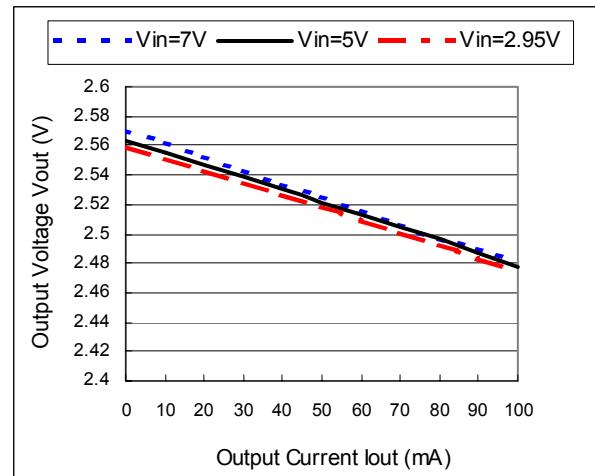
##### 6.4.3. Output voltage vs. output current ( $V_{out} = 2.7V$ )



##### 6.4.2. Output voltage vs. output current ( $V_{out} = 3.0V$ )

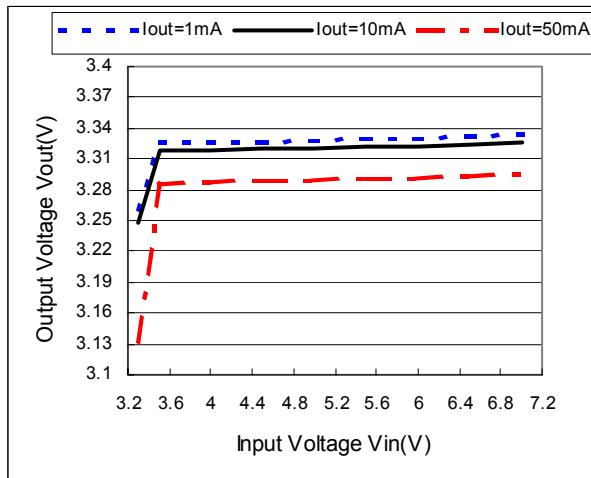


##### 6.4.4. Output voltage vs. output current ( $V_{out} = 2.55V$ )

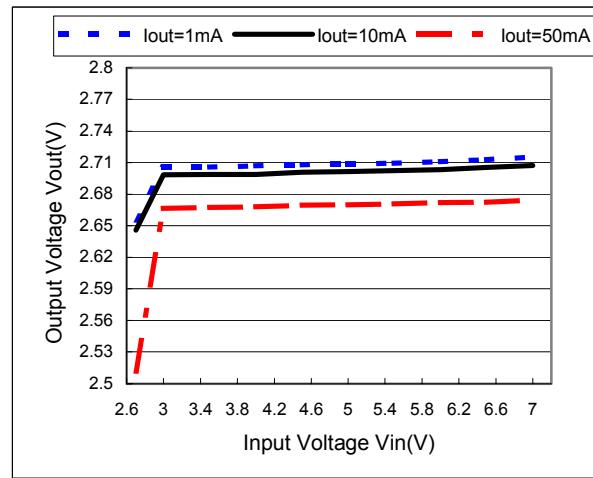




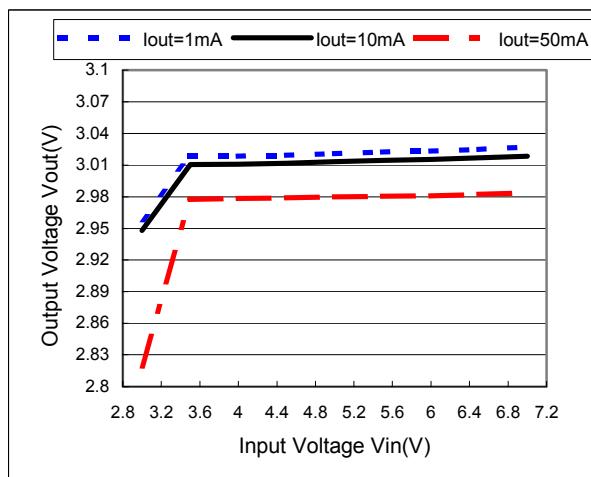
#### 6.4.5. Output voltage vs. input voltage (Vout = 3.3V)



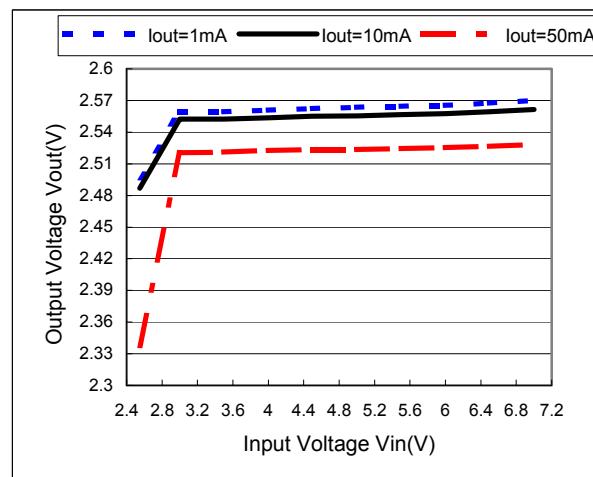
#### 6.4.7. Output voltage vs. input voltage (Vout = 2.7V)



#### 6.4.6. Output voltage vs. input voltage (Vout = 3.0V)

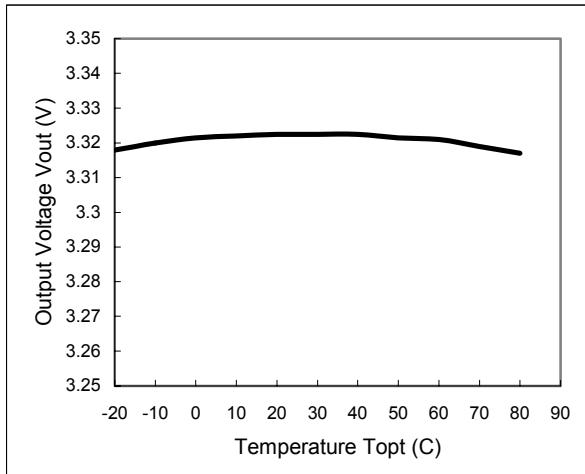


#### 6.4.8. Output voltage vs. input voltage (Vout = 2.55V)

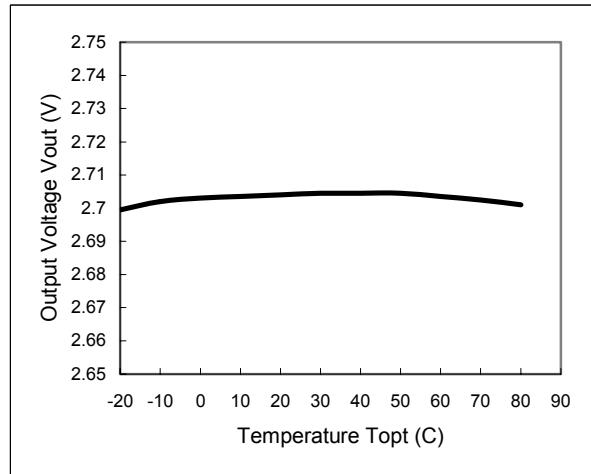




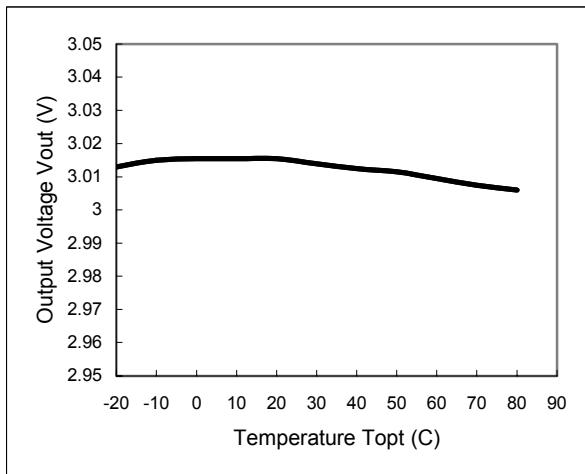
#### 6.4.9. Output voltage vs. temperature ( $V_{out} = 3.3V$ )



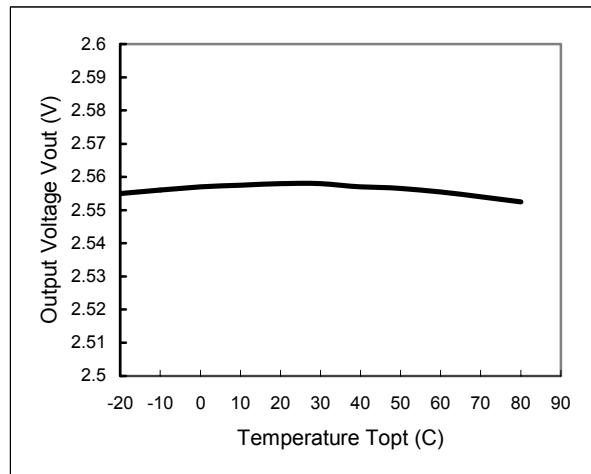
#### 6.4.11. Output voltage vs. temperature ( $V_{out} = 2.7V$ )



#### 6.4.10. Output voltage vs. temperature ( $V_{out} = 3.0V$ )



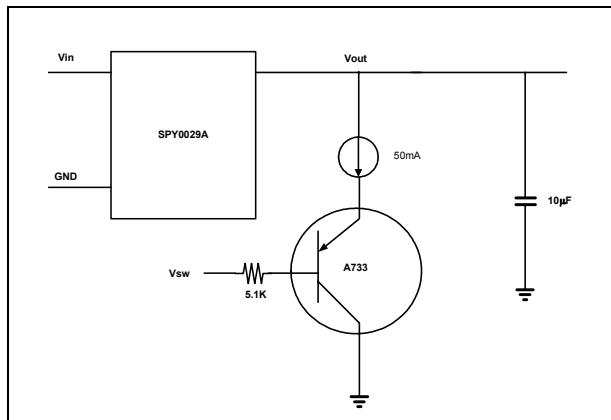
#### 6.4.12. Output voltage vs. Temperature ( $V_{out} = 2.55V$ )



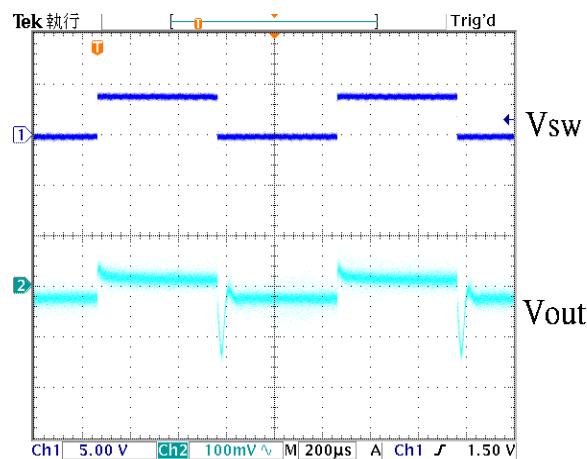


#### 6.4.13. Load –transient response test module

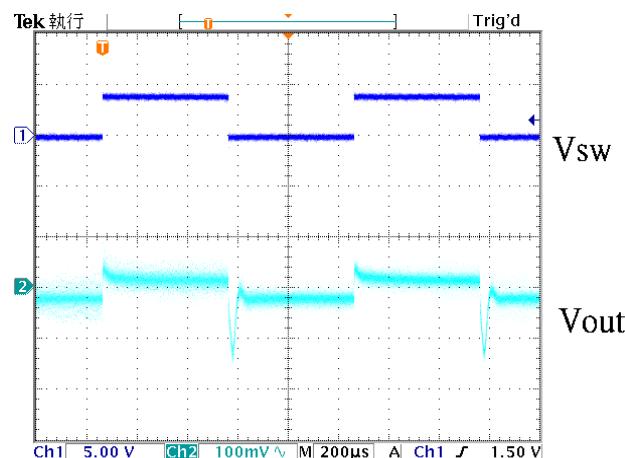
( $V_{IN} = 5V$ ,  $I_{OUT} = 0$  to  $50mA$ ,  $C_{LOAD} = 10\mu F$ )



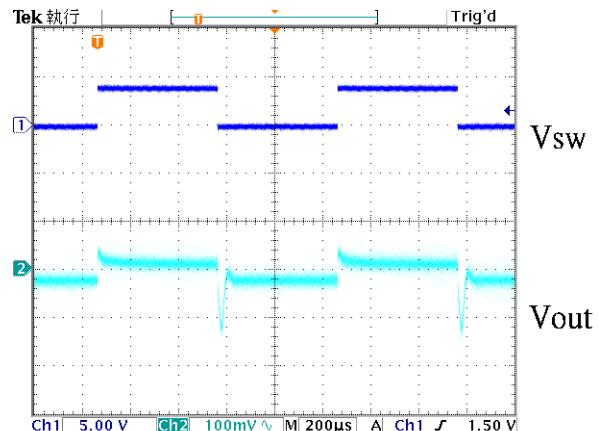
#### 6.4.14. Load –transient response; Vout = 3.3V



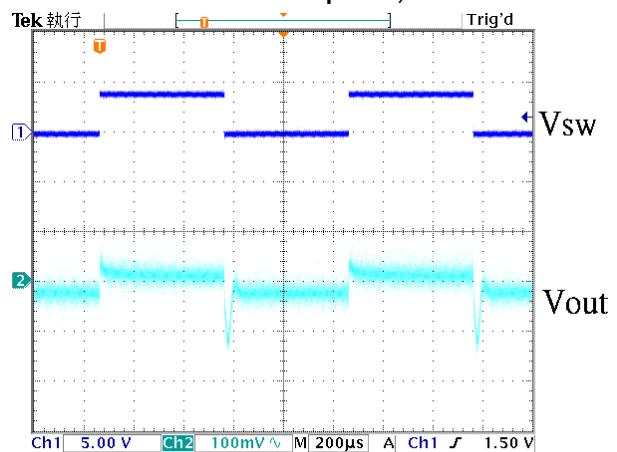
#### 6.4.15. Load –transient response; Vout = 3.0V



#### 6.4.16. Load –transient response; Vout = 2.7V

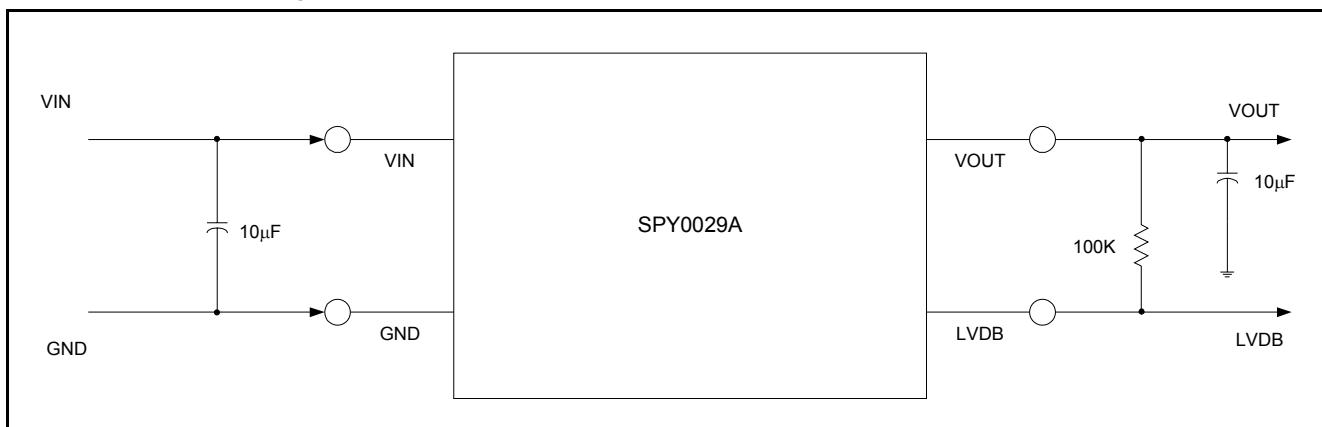


#### 6.4.17. Load –transient response; Vout = 2.55V

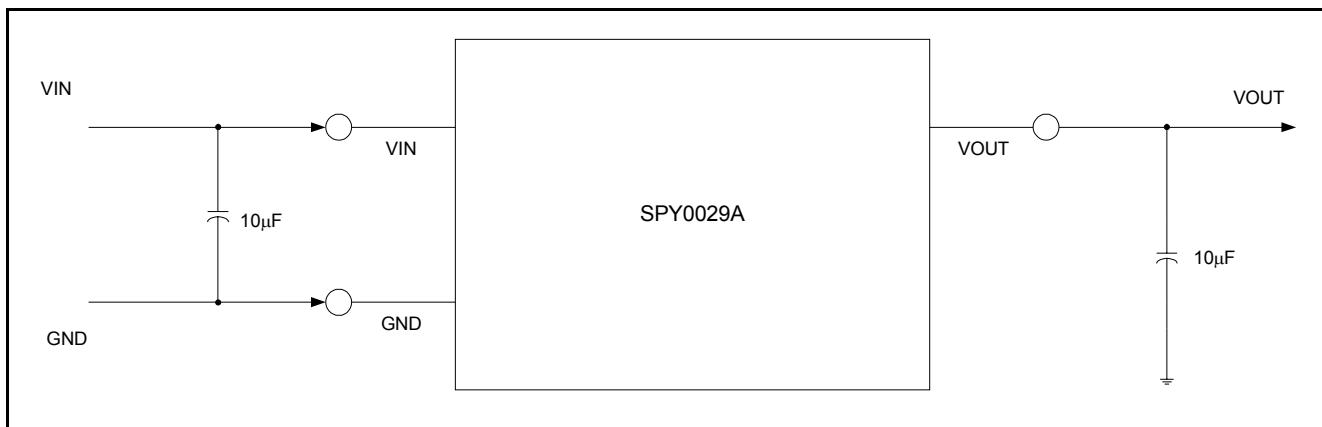


## 6. APPLICATION CIRCUIT

### 6.1. 4 PIN (with Low Voltage Detected Function)

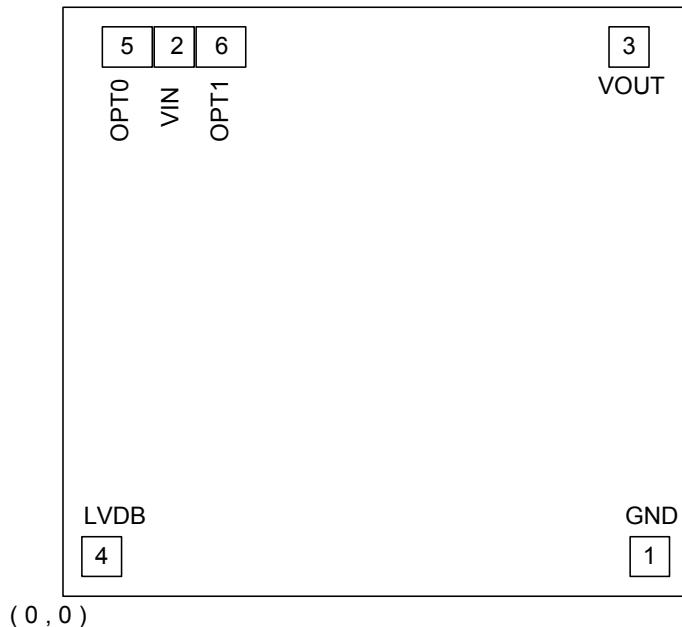


### 6.2. 3 PIN (no Low Voltage Detected Function)



## 7. PACKAGE/PAD LOCATIONS

### 7.1. PAD Assignment



Chip Size: 1050 $\mu\text{m}$  × 1180 $\mu\text{m}$

This IC substrate should be connected to VSS

**Note1:** Chip size included scribe line.

**Note2:** To ensure that the IC functions properly, please bond all of VDD and VSS pins.

**Note3:** The 0.1 $\mu\text{F}$  capacitor between VDD and VSS should be placed to IC as close as possible.

### 7.2. Ordering Information

Product Number	Package Type
SPY0029A-C	Chip form
SPY0029A-PE01	Package form - SOT89
SPY0029A-PE02	Package form - SOT92

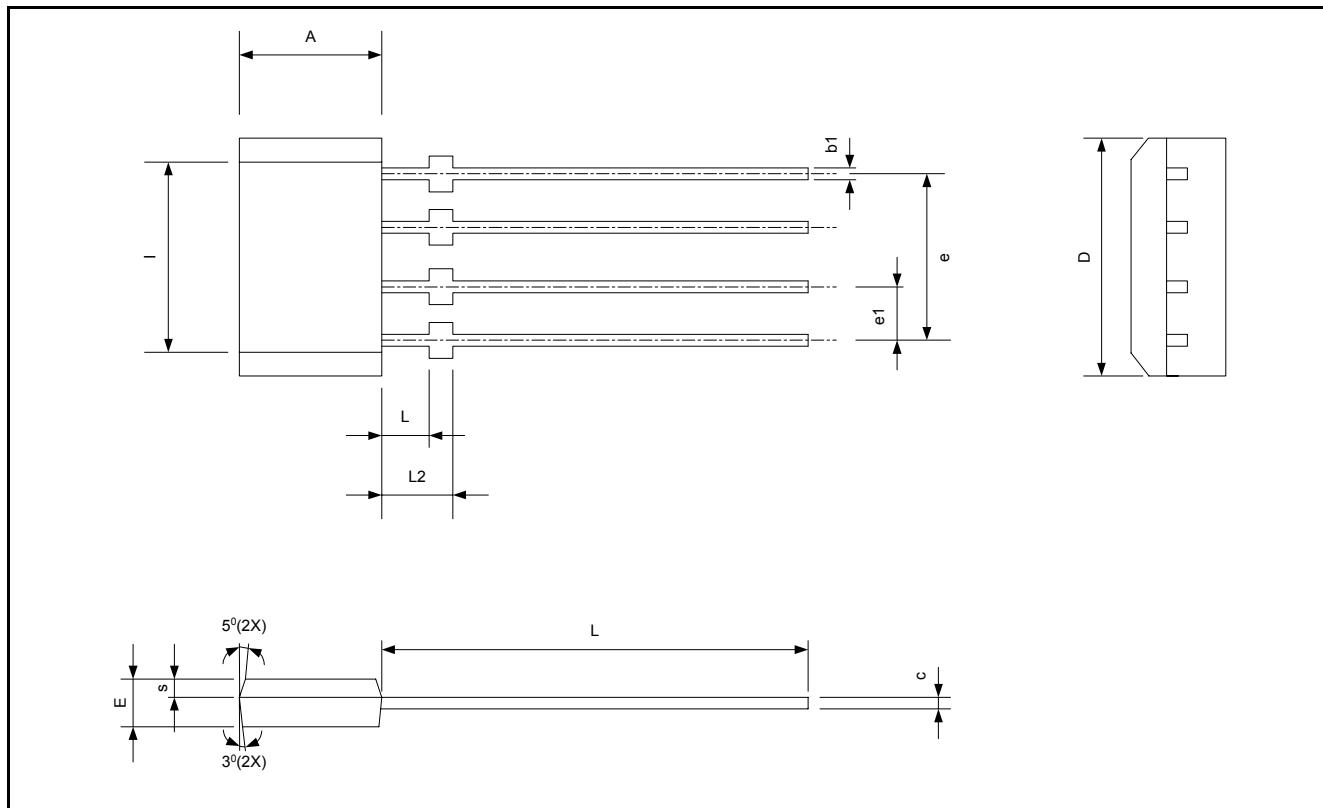
### 7.3. PAD Locations

PAD No.	PAD Name	X	Y
1	GND	821	110
2	VIN	363	972
3	VOUT	770	972
4	LVDB	153	105
5	OPT0	153	972
6	OPT1	573	972



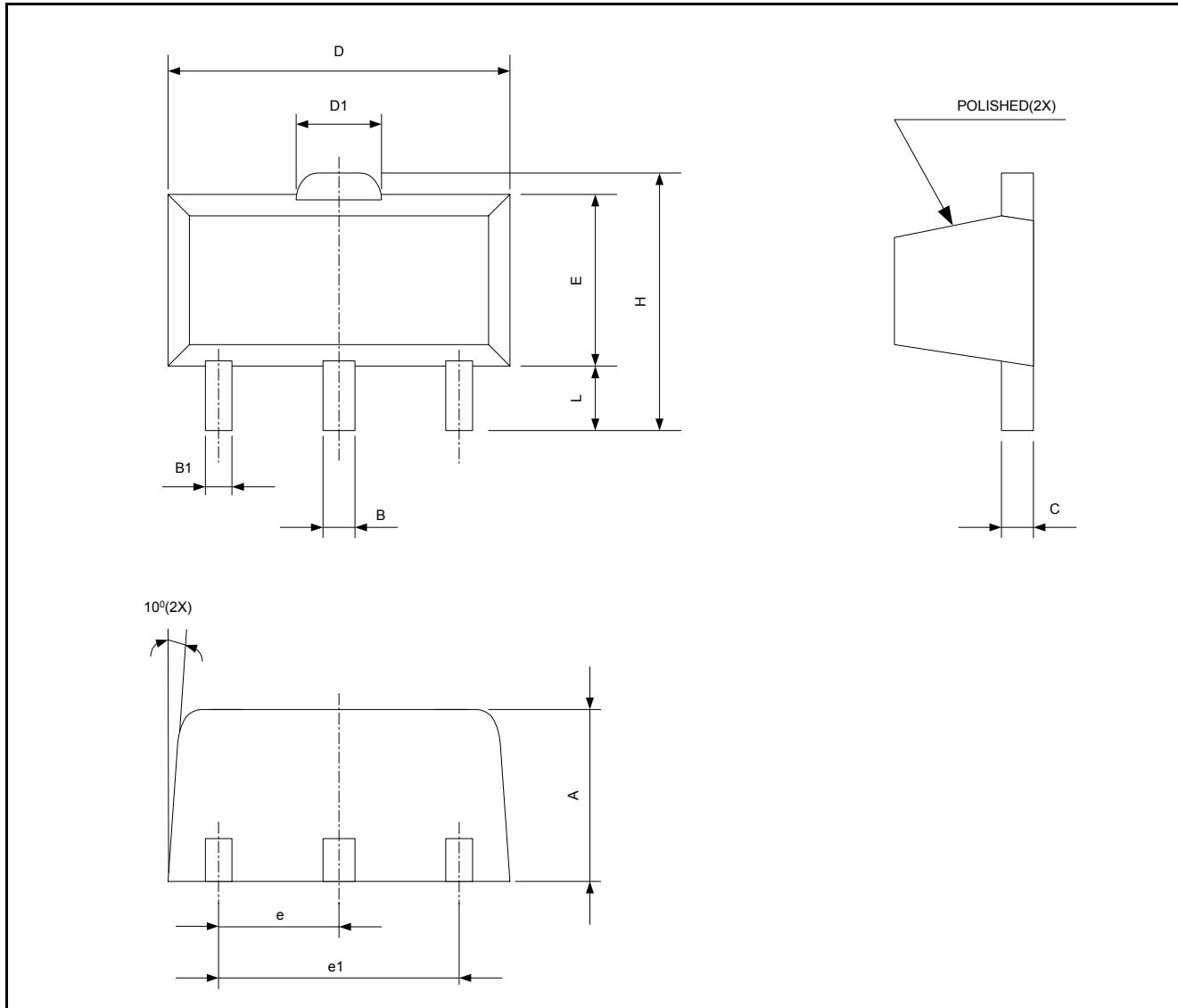
## 7.4. Package Information

### 7.4.1. 4 PIN SOT92 package size



Symbol	Min.	Nom.	Max.	Unit
A	3.60	3.65	3.70	Millimeter
b1	0.35	0.38	0.41	Millimeter
c	0.351	0.381	0.411	Millimeter
D	5.17	5.22	5.27	Millimeter
e	3.78	3.81	3.84	Millimeter
e1	1.24	1.27	1.30	Millimeter
E	1.50	1.55	1.60	Millimeter
I	4.04	4.20	4.34	Millimeter
L	13.8	14.3	14.8	Millimeter
L1	0.814	0.914	1.014	Millimeter
L2	1.342	1.442	1.542	Millimeter
s	0.70	0.73	0.76	Millimeter

#### **7.4.2. 3 PIN SOT89 package size**



Symbol	Min.	Max.	Unit
A	1.40	1.60	Millimeter
B	0.44	0.56	Millimeter
B1	0.36	0.48	Millimeter
C	0.35	0.44	Millimeter
D	4.40	4.60	Millimeter
D1	1.35	1.83	Millimeter
E	2.29	2.60	Millimeter
H	3.94	4.25	Millimeter
e	1.50 BSC		Millimeter
e1	3.00 BSC		Millimeter
L	0.89	1.2	Millimeter

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## 10. REVISION HISTORY

Date	Revision #	Description	Page
JUL. 10, 2002	0.1	Original	12
OCT.15, 2002	0.2	<ul style="list-style-type: none"><li>1. Update quiescent current = 3.0<math>\mu</math>A in Features</li><li>2. Update quiescent current = 3.0<math>\mu</math>A in DC characteristic</li><li>3. Add V<sub>OUT</sub> = 3.3V into test conditions of DC characteristic</li><li>4. Add Note1 figure into bonding option</li><li>5. Add typical operating characteristic figures from page 6 to page 9 (6.4.1 ~ 6.4.17)</li></ul>	<ul style="list-style-type: none"><li>3</li><li>5</li><li>5</li><li>5</li><li>6</li></ul>